



DONGGUAN NANJING ELECTRONICS LTD.,  
**TO-247-2 Silicon Carbide Schottky Diode**

**NJ12020U2** SiC Diode 1200V, 20A, 132nC

### General Description

This product family offers state of the art performance. It is designed for high frequency applications here high efficiency and high reliability are required.

### Features

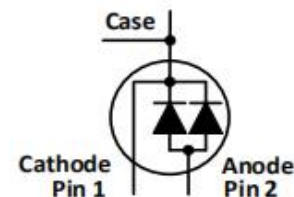
- Max junction temperature 175°C
- High surge current capacity
- Zero reverse recovery current
- Zero forward recovery voltage
- High frequency operation
- Temperature independent switching behavior
- Positive temperature coefficient on  $V_F$



**TO-247-2  
Pin definition**

### Applications

- Solar booster
- EV charger piles
- Inverter free wheeling diode
- Vienna 3-Phase PFC
- AC/DC Converters
- Switch Mode Power Supplies



### Key performance parameters

Type	$V_{RRM}$	$I_F$ $T_C=150^\circ\text{C}$	$Q_C$
NJ12020U2	1200V	20A	132nC

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handing procedures.

## Typical Characteristics

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### Maximum Ratings

$T_C=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	1200	V
DC Peak Reverse Voltage	$V_{DC}$	1200	V

### Maximum Ratings

$T_C=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Value	Unit
Continuous Forward Current: $T_C = 25^{\circ}\text{C}$ $T_C = 150^{\circ}\text{C}$	$I_F$	83 22	A
Non-Repetitive Forward Surge Current: Sine half wave $T_C = 25^{\circ}\text{C}$ $t_p = 10\text{ms}$	$I_{FSM}$	125	A
Power Dissipation: $T_C = 25^{\circ}\text{C}$ $T_C = 150^{\circ}\text{C}$	$P_{tot}$	272 45	W
$i^2t$ value : $T_C = 25^{\circ}\text{C}$ $t_p = 10\text{ms}$	$\int i^2 dt$	78	$\text{A}^2\text{S}$
Operating Junction temperature Range	$T_j$	-55 to +175	$^{\circ}\text{C}$
Storage temperature Range	$T_{stg}$	-55 to +175	$^{\circ}\text{C}$

## Typical Characteristics

### Thermal Resistance

Parameter	Symbol	Typ.	Unit
Thermal resistance of crust	$R_{thJC}$	0.55	°C/W

### Electrical Characteristic

$T_C = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Value			Unit	Test Condition
		Min.	Typ.	Max.		
Forward Voltage	$V_F$		1.54 2.20	1.8 3.0	V	$I_F = 20\text{A}$ $T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$
Reverse Current	$I_R$		14 49	100 350	uA	$V_R = 1200\text{V}$ $T_j = 25^\circ\text{C}$ $T_j = 175^\circ\text{C}$
Total Capacitive Charge	$Q_C$		132		nC	$V_R = 800\text{V}$ $T_j = 25^\circ\text{C}$ $Q_C = \int_0^{V_R} C(V)dV$
Total Capacitance	C		1160 113 78		pF	$T_j = 25^\circ\text{C}$ , $f = 1\text{MHz}$ $V_R = 1\text{V}$ $V_R = 400\text{V}$ $V_R = 800\text{V}$

Characteristics Curve

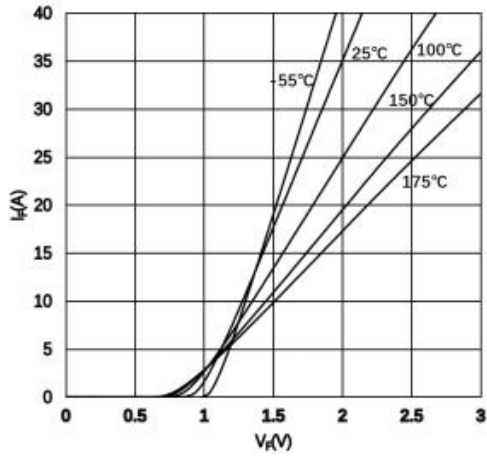


Fig. 1 Typical forward characteristic curve

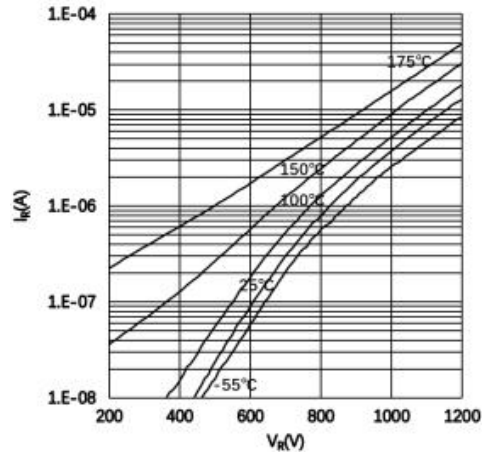


Fig. 2 Typical reverse characteristic curve

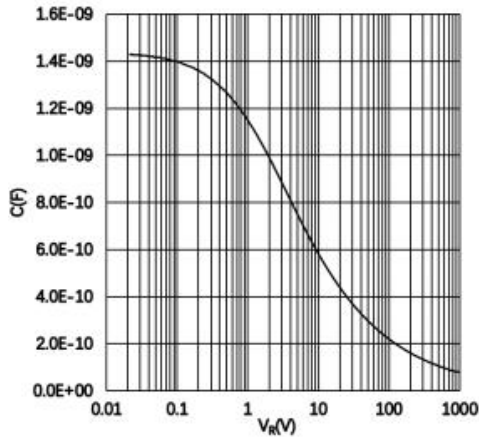


Fig. 3 Typical capacitance and reverse voltage curve

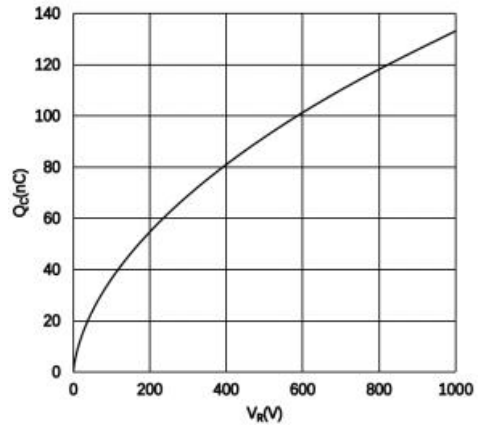


Fig. 4 Typical storage charge and reverse voltage curve

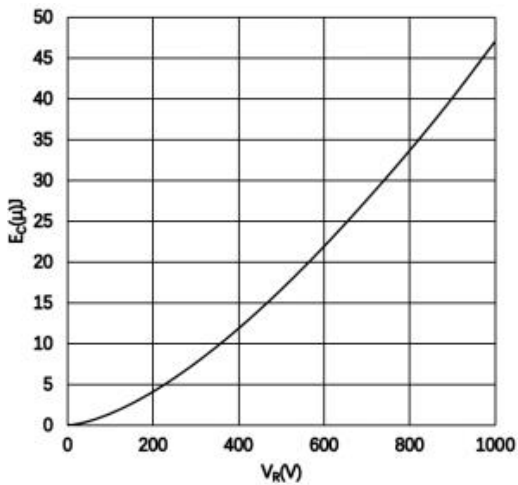


Fig. 5 Typical capacitance energy and reverse voltage curve

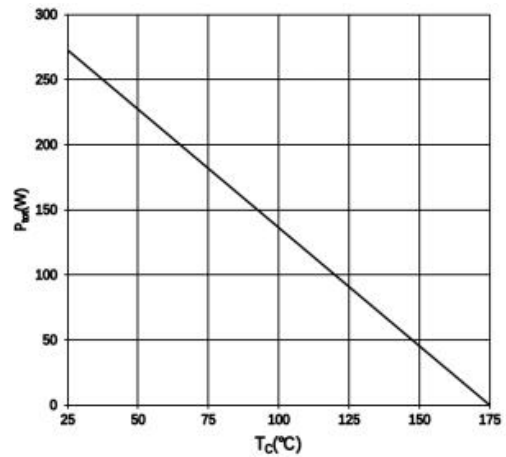


Fig. 6 Typical power derating curve

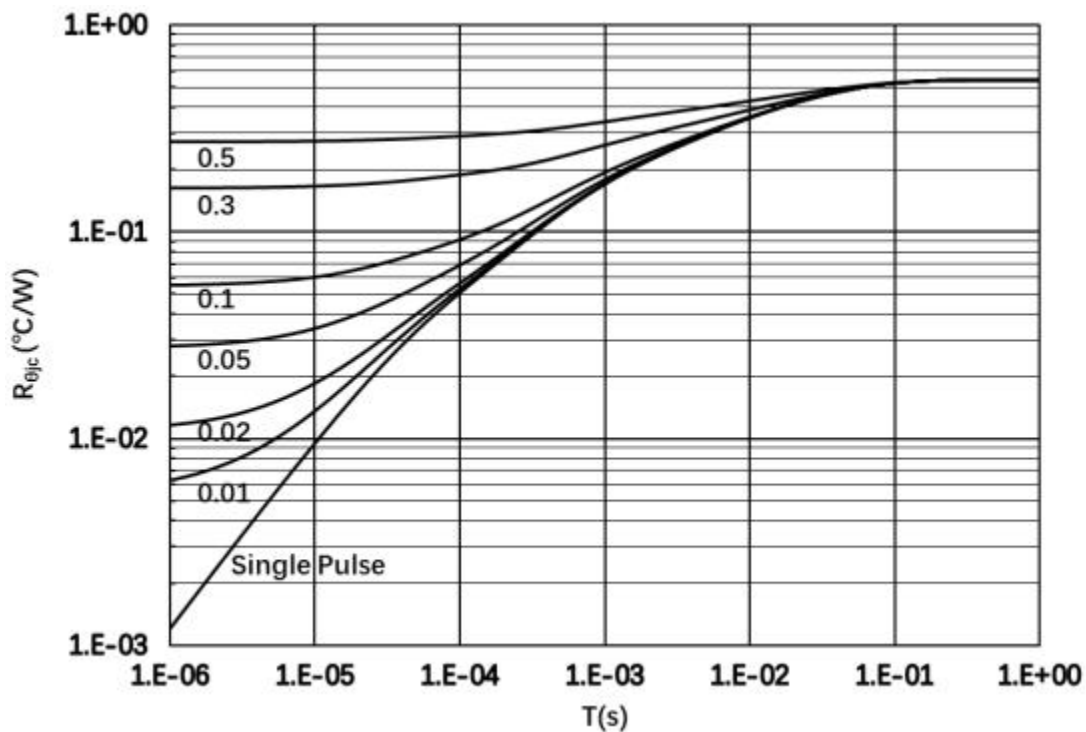
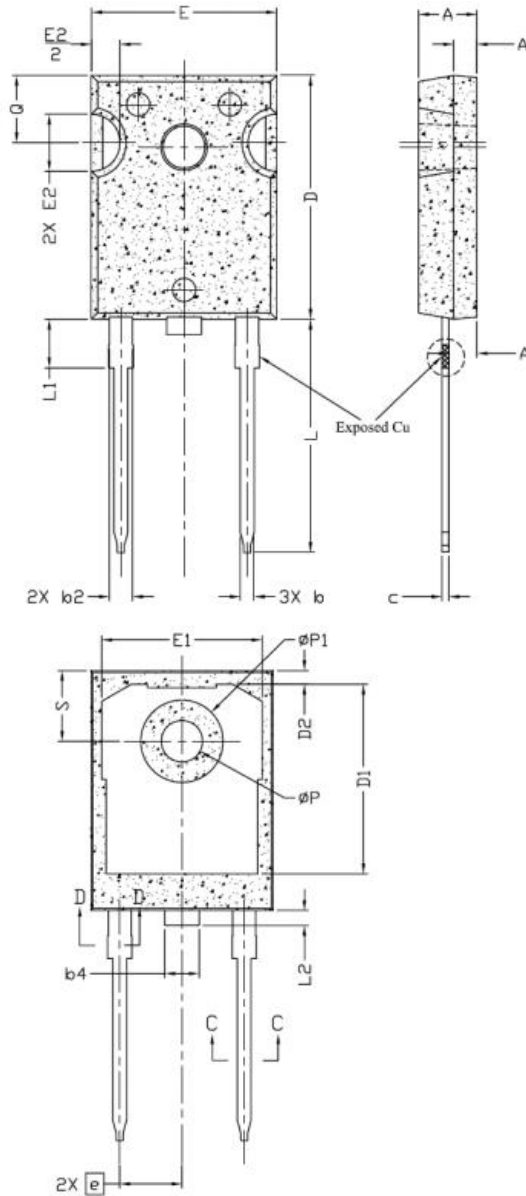


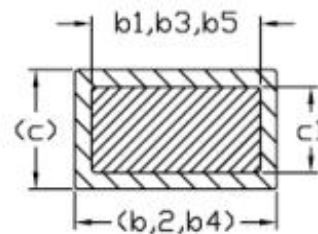
Fig. 7 Transient thermal impedance

Package Outline:TO-247-2



SYMBOL	DIMENSIONS			NOTES
	MIN.	NOM.	MAX.	
A	4.83	5.02	5.21	
A1	2.29	2.41	2.55	
A2	1.50	2.00	2.49	
b	1.12	1.20	1.33	
b1	1.12	1.20	1.28	
b2	1.91	2.00	2.39	6
b3	1.91	2.00	2.34	
b4	2.87	3.00	3.22	6, 8
b5	2.87	3.00	3.18	
c	0.55	0.60	0.69	6
c1	0.55	0.60	0.65	
D	20.80	20.95	21.10	4
D1	16.25	16.55	17.65	5
D2	0.51	1.19	1.35	
E	15.75	15.94	16.13	4
E1	13.46	14.02	14.16	5
E2	4.32	4.91	5.49	3
e	5.44BSC			
L	19.81	20.07	20.32	
L1	4.10	4.19	4.40	6
L2	1.00	1.30	1.50	
∅P	3.56	3.61	3.65	7
∅P1	6.90	7.09	7.15	
Q	5.39	5.79	6.20	
S	6.04	6.17	6.30	

Dimensions in (mm)



Section C-C, D-D